Vishay Siliconix

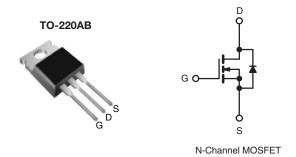
RoHS

COMPLIANT

FREE

E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.28			
Q _g max. (nC)	76				
Q _{gs} (nC)	11				
Q _{gd} (nC)	17				
Configuration	Single				



FEATURES

- Low Figure-of-Merit (FOM) Ron x Qq
- Low Input Capacitance (C_{iss})
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q_g)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP15N60E-E3			
Lead (Pb)-free and Halogen-free	SiHP15N60E-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwi			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600		
Gate-Source Voltage				± 20	V	
Gate-Source Voltage AC (f > 1 Hz)			V _{GS}	30		
Continuous Drain Current (T _J = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	15	А	
	V _{GS} at 10 V	T _C = 100 °C		9.6		
Pulsed Drain Current ^a			I _{DM}	39		
Linear Derating Factor				1.4	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	102	mJ	
Maximum Power Dissipation			P _D	180	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	$T_{J} = 1$	T _J = 125 °C		37	\//	
Reverse Diode dV/dt ^d			dV/dt	7.7	- V/ns	
Soldering Recommendations (Peak Temperature) for 10 s			300°	°C		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 11.6 mH, $R_g = 25 \Omega$, $I_{AS} = 4.2 \text{ A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.7	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•	•		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8 A	-	0.23	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS}	s = 30 V, I _D = 8 A	-	4.6	-	S
Dynamic						I	
Input Capacitance	C _{iss}		Voc = 0 V	-	1350	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		-	70	-	1
Reverse Transfer Capacitance	C _{rss}	1	f = 1 MHz		5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	53	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	177	-	
Total Gate Charge	Qg			-	38	76	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 8 A, V_{DS} = 480 V$	-	11	-	nC
Gate-Drain Charge	Q _{gd}			-	17	-	
Turn-On Delay Time	t _{d(on)}			-	17	34	
Rise Time	t _r	V_{DD} = 480 V, I_{D} = 8 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		-	51	77	ns
Turn-Off Delay Time	$t_{d(off)}$			-	35	70	
Fall Time	t _f			-	33	66	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.86	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	
Pulsed Diode Forward Current	I _{SM}			-	-	60	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	410	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	25 °C, I _F = I _S = 8 A,	_	5.4	-	μC
Reverse Recovery Current	I _{RRM}	dl/dt = 100 A/ μ s, V_R = 20 V		_	21	_	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

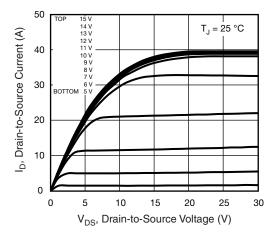


Fig. 1 - Typical Output Characteristics

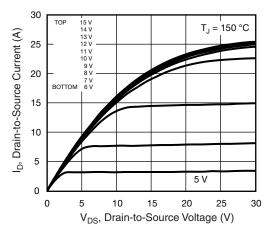


Fig. 2 - Typical Output Characteristics

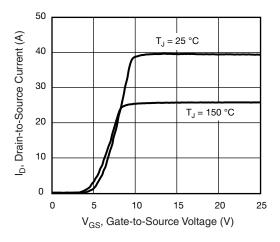


Fig. 3 - Typical Transfer Characteristics

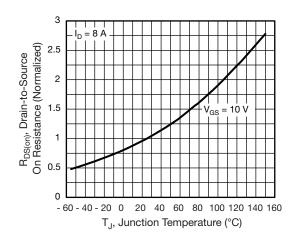


Fig. 4 - Normalized On-Resistance vs. Temperature

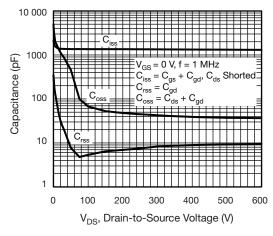


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

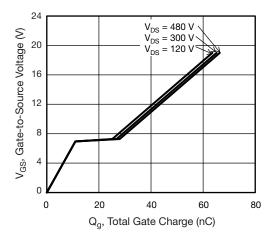


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



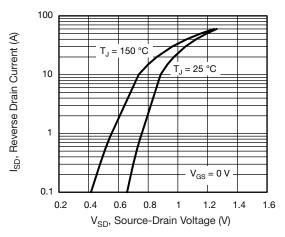


Fig. 7 - Typical Source-Drain Diode Forward Voltage

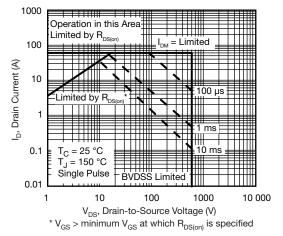


Fig. 8 - Maximum Safe Operating Area

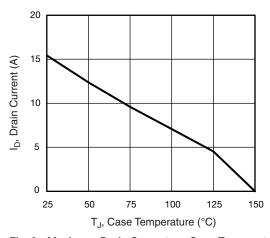


Fig. 9 - Maximum Drain Current vs. Case Temperature

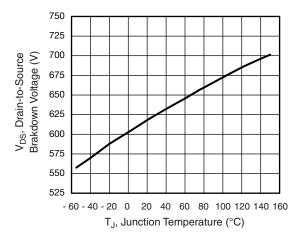


Fig. 10 - Temperature vs. Drain-to-Source Voltage

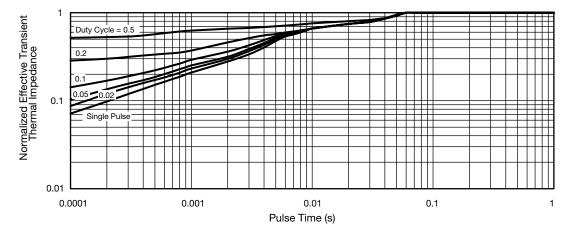


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



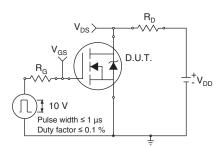


Fig. 12 - Switching Time Test Circuit

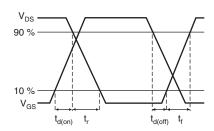


Fig. 13 - Switching Time Waveforms

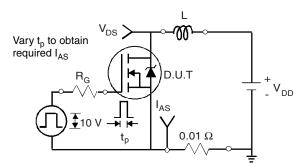


Fig. 14 - Unclamped Inductive Test Circuit

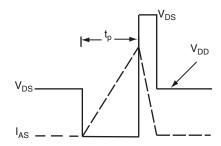


Fig. 15 - Unclamped Inductive Waveforms

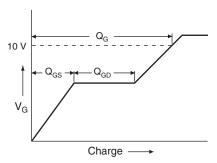


Fig. 16 - Basic Gate Charge Waveform

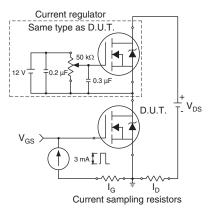
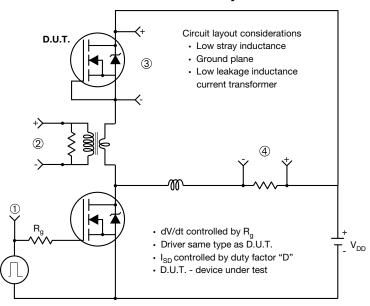


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



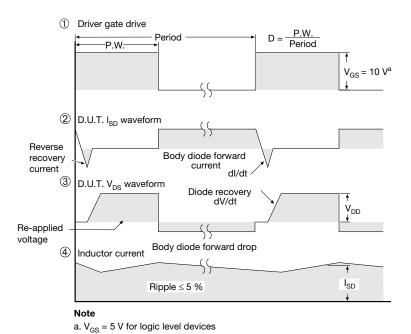


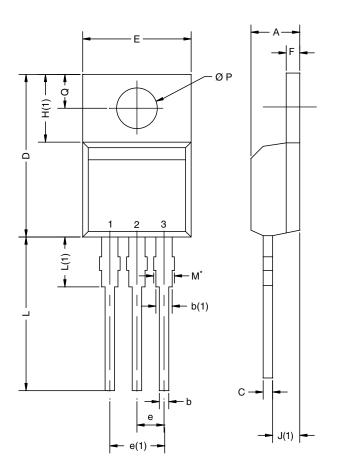
Fig. 18 - For N-Channel

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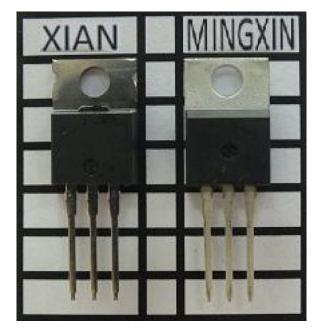
TO-220AB



	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

Notes

- * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM
- · Xi'an and Mingxin actual photo





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Vishay

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